

**Released Engineering Change Notice**

Product	<b>XONE:DX</b>
Title	<b>Improved headphone grounding to reduce noise and prevent loss of signal</b>
Date	28/06/2010

Details Of Change
<p><b>Base metalwork Mic/Headphone PCB area (front of base) needs to be masked to enable good electrical contact between the base metal and the PCB brackets and XLR screws</b></p> <p><b>Chassis AA7427 to be up-issued to issue 11 (UK),12 (Vtech)</b></p>

Reason for change
<p><b>The Master PCB headphone amp U3 uses this contact as the ground rail, and poor contact results in faults ranging from noise to failure to pass a signal.</b></p>

This ECN supersedes ECN No.	<table border="1"> <tr> <td></td> <td></td> </tr> </table>		
	Related ECNs		

Post Implementation Ser No		
Serial Number	Model	Date
XDX-003658, XDXX-201692		

Serial Number	Model	Date

Additional Information
<p><b>Older units: Base metalwork paint can be removed around the headphone/mic PCB to allow better ground contact.</b></p>